GENERAL PURPOSE SI MOSFET RELAY ▲ AK70 SERIES



AK70 SERIES

GENERAL PURPOSE A Si MOSFET RELAY

SILICON SI MOSFET RELAY ▲ DIP and SMD type Switches AC or DC load Normally open and normally closed switch in one package Input TTL / CMOS compatible Moisture Sensitivity Level A MSL 1

UL 1577 approved ▲ File no E344988

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SPECIFICATION

Item		Characteristics
Contact Form		1 Form A / 1 Form B ▲ Normally open / closed switch
Load Voltage	VL	60V
Operation LED Current	I _{F ON}	3mA
Load Current	l,	380mA
On-Resistance	R _{ON}	0.75Ω
Output Capacitance	Соит	45pF / 165pF
Low Off-State Leakage Current	ILEAK	10μA at 60V _{DC}

RoHS

REACH

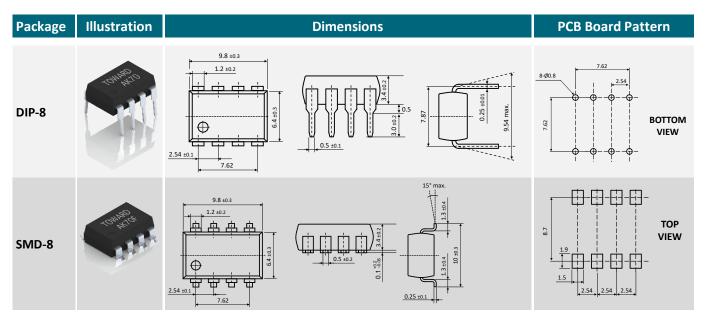
HALOGEN

FREE

APPLICATIONS

Automatic Test	l/O	Industrial	Measurement	Security	Sensing	Telecom
Equipment	Modules	Automation	Equipment	Equipment	Equipment	Equipment
			•••• 0		∿•)))	

DIMENSIONS

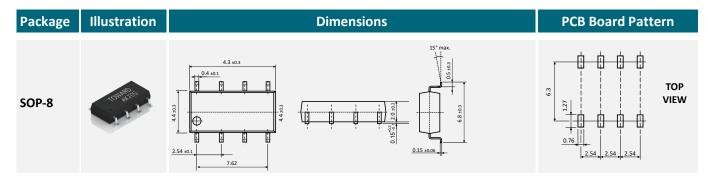


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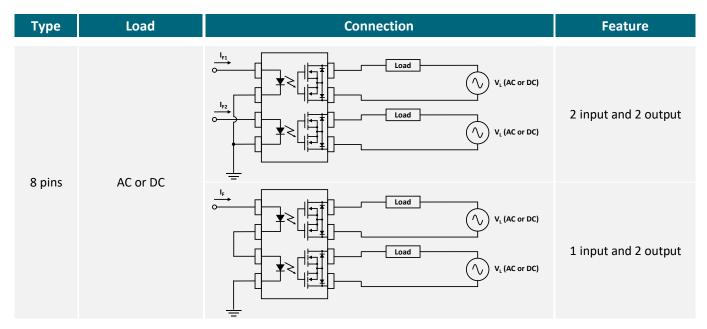
DIMENSIONS



PIN DESCRIPTION AND PART NUMBER

Circuit Diagram	Pin Description	Part No.	Package	Packing
	1,3 Anode (+) • LED 2,4 Cathode (-) • LED 5,6,7,8 Drain • MOSFET	AK70 AK70F AC70S AK70F-R1 AK70S-R1	DIP-8 SMD-8 SOP-8 SMD-8 SOP-8	Tube (45pcs) Tube (45pcs) Tube (50pcs) Reel (1000pcs) Reel (1000pcs)

LOAD CONNECTING METHOD





ABSOLUTE MAXIMUM RATINGS **A** AMBIENT TEMPERATURE T_A = 25°C

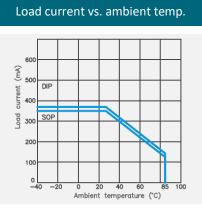
	ltem	Condition	Symbol		Value		Unit
	Outline package			DIP-8	SMD-8	SOP-8	
Туре	Part number			AK70	AK70F	AK70S	
	Output channels			2 (1a + 1b)	2 (1a + 1b)	2 (1a + 1b)	Channel
	Continuous LED Current		I _F		50		mA
lanut	Peak LED Current	100 Hz, Duty 1%	I _{FP}		500		mA
Input	LED Reverse Voltage		V _R		5		V
	Input Power Dissipation		P _{IN}		75		mV
	Load Voltage		VL	e	50 (AC peak or D	C)	V
Output	Load Current		I _L	380	380	350	mA
Output	Peak Load Current	1 ms, 1 shot	I _{PEAK}	1000	1000	1000	mA
	Output Power Dissipation		P _{OUT}	600	600	400	mW
	Total Power Dissipation		PT	650	650	450	mW
Polov	I/O Breakdown Voltage		V _{I/O}		1500		V _{RMS}
Relay	Operating Temperature Range		T _{OPR}		-40 to +85		°C
	Storage Temperature Range		T _{STG}		-40 to +100		°C

ELECTRICAL CHARACTERISTICS AMBIENT TEMPERATURE $T_A = 25^{\circ}C$

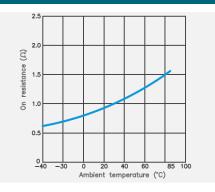
	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I _F = 10mA	VF	1	1.17	1.5	V
Input	Operation LED Current		I _{F ON}		0.9	3	mA
	Recovery LED Voltage		V_{FOFF}	0.5	1		V
	On-Resistance Drain to Drain (tested within 1 sec.)	I _F =5mA (NO), I _F =0mA (NC), I∟=Rating	R _{on}		0.75	1	Ω
Output	Off-State Leakage Current	I _F =0mA (NO), I _F =5mA (NC), V _L = 60V	I _{LEAK}			1(NO) 10(NC)	μΑ
	Output Capacitance	I _F =0mA (NO), I _F =5mA (NC), V _L =0V, f=1MHz	Соит		45(NO) 165(NC)		pF
	Turn-On Time (for SOP type)	I _F =5mA, I _L =Rating	t _{on_(no)} t _{on_(nc)}		0.2(NO) 0.35(NC)	1	ms
Trans-	Turn-Off Time (for SOP type)	$I_F=5mA$, $I_L=Rating$	t _{OFF_(NO)} t _{OFF_(NO)}		0.05	0.5	ms
mission	Turn-On Time (for DIP/SMD type)	I _F =10mA, I _L =Rating	t _{on_(no)} t _{on_(nc)}		0.2(NO) 0.25(NC)	1	ms
	Turn-Off Time (for DIP/SMD type)	I _F =10mA, I _L =Rating	t _{OFF_(NO)} t _{OFF_(NO)}		0.05	0.5	ms
Coupled	I/O Insulation Resistance		R _{I/O}	10 ⁹			Ω
Coupled	I/O Capacitance	f=1MHz	C _{I/O}		1.3		рF



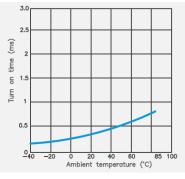
REFERENCE DATA



On resistance vs. ambient temp.

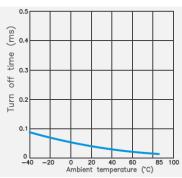


Turn on time vs. ambient temp.

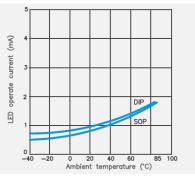


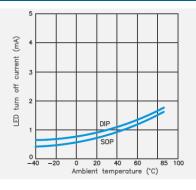
LED turn off current vs. ambient temp.

Turn off time vs. ambient temp.

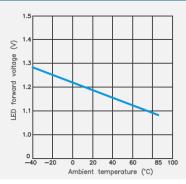


LED operate current vs. ambient temp



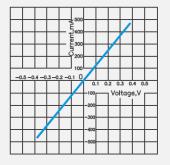


LED forward voltage vs. ambient temp.

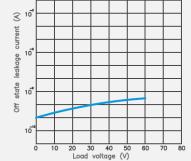


output at MOS portion

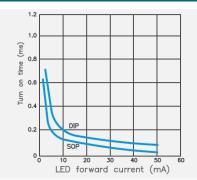
Current vs. voltage characteristics of



Off state leakage current vs. load voltage



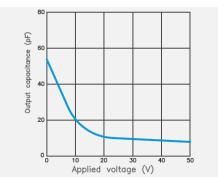
Turn on time vs. LED forward current



Turn off time vs. LED forward current



Output capacitance vs. applied voltage

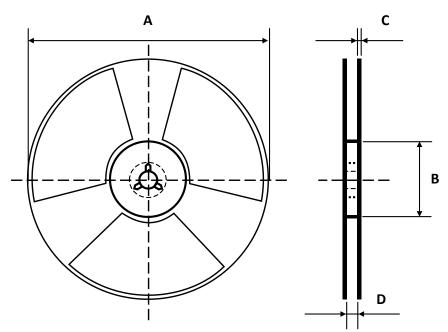


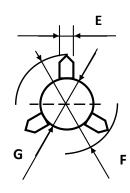
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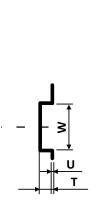
REEL DIMENSIONS All dimensions in mm

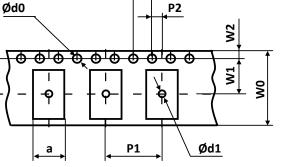




Size	А	В	С	D	E	F	G
SOP-8	330	100	2	17	2	13	21
SMD-8	380	80	2.2	17	2	13	21

TAPE DIMENSIONS All dimensions in mm





P0

Feed Direction

Size	w	U	т	а	Ød0	Ød1	P0	P1	P2	W0	W1	W2
SOP-8	10.4	0.3	2.3	7.5	1.5	1.5	4	12	2	16	7.5	1.75
SMD-8	9.9	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75



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PACKING QUANTITIES

Tape and Reel Packing	PCS/Reel
SMD-8	1000
SOP-8	1000

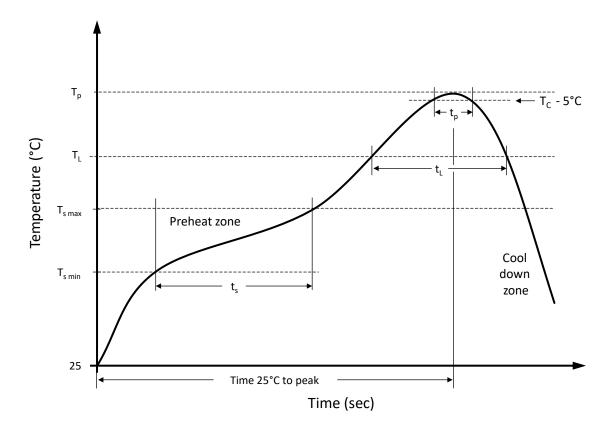
Tube Packing	PCS/Tube	Tubes/Box	Units/Box
DIP-8	45	30	1350

STORAGE AND HANDLING CONDITIONS

ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T _A < 30°C, RH < 85%	1



RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE



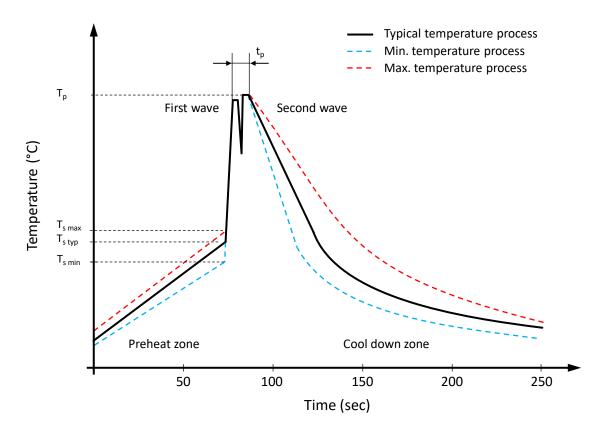
Recommended reflow soldering conditions ▲ Refer to JEDEC J-STD-020E

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T_{smin}	100 °C	150 °C
Preheat temperature max.	T_{smax}	150 °C	200 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	120 seconds	120 seconds
Ramp-up rate (T_L to T_p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	ΤL	183 °C	217 °C
Time t_L maintained above T_L	tL	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t _p	20 seconds max.	30 seconds max.
Ramp-down rate (T_L to T_p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes

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RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	T_{smin}	100 °C	100 °C
Preheat temperature typical	T _{s typ}	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t _p	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



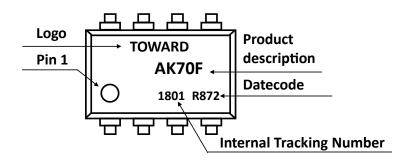
PRODUCT CODE

AK		70		F		R1	
Package		Series		Туре		Packing	
AK	8 Pin ▲ 1 Form A 1 Form B	70	60V	Blank F S	DIP SMD SOP	Blank R1	Tube Reel

Example: AK70F series **A** 1 Form A / 1 Form B **A** 60V **A** SMD-8 **A** Tape & Reel

PRODUCT MARKING

Example: AK70F series **A** 1 Form A / 1 Form B **A** 60V **A** SMD-8 **A** Tape & Reel



DATE CODE

Example: R872

[R	3	3	7	7	2	2
Material Characteristics		Year		Month		Week of the Month	
R	RoHS compliant Halogen free	8 9 A B C	2018 2019 2020 2021 2022	1 2 3 4 5	Jan Feb Mar Apr May	1 2 3 4	1 st 2 nd 3 rd 4 th
	inee	 G	 2026	 12	 Dec		



RELIABILITY TESTS A STANDARD

Standard: JESD22-A

No.	Test	Test	Test	Test	
1	Moisture Sensitivity Level Test	Specification Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	Standard JESD22-A113H	Limits No abnormal phenome- non was found. Functional test passed.	
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenome- non was found. Functional test passed.	
3	Temperature Cycling Test	Temperature range: -55°C to +125°C -55°C for 30 minutes +125°C for 30 minutes Duration: 100 cycles with 1 cycle = 70 minutes	JESD22-A104E	No abnormal phenome- non was found. Functional test passed.	
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenome- non was found. Functional test passed.	
5	Temperature & Humidity Storage Test	Temperature: 85°C Humidity: 85% RH Duration: 500 hours	JESD22-A101D	No abnormal phenome- non was found. Functional test passed.	
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A-118B	No abnormal phenome- non was found. Functional test passed.	



REVISION TABLE

Revision	Date	Status	Notes
001	01/10/2021	Initial release	Initial publication

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